

INTERNATIONAL STANDARD

ISO
9869-2

First edition
2018-08

AMENDMENT 1
2021-06

Thermal insulation — Building elements — In-situ measurement of thermal resistance and thermal transmittance —

Part 2:

**Infrared method for frame structure
dwelling**

(<https://standards.iteh.ai>)
AMENDMENT 1: Example of calculation
Doc of uncertainty analysis

[ISO 9869-2:2018/Amd.1:2021](https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021)

<https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021>



Reference number
ISO 9869-2:2018/Amd.1:2021(E)

© ISO 2021

iTeh Standards
(<https://standards.iteh.ai>)
Document Preview

[ISO 9869-2:2018/Amd 1:2021](https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021)

<https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021>



COPYRIGHT PROTECTED DOCUMENT

© ISO 2021

All rights reserved. Unless otherwise specified, or required in the context of its implementation, no part of this publication may be reproduced or utilized otherwise in any form or by any means, electronic or mechanical, including photocopying, or posting on the internet or an intranet, without prior written permission. Permission can be requested from either ISO at the address below or ISO's member body in the country of the requester.

ISO copyright office
CP 401 • Ch. de Blandonnet 8
CH-1214 Vernier, Geneva
Phone: +41 22 749 01 11
Email: copyright@iso.org
Website: www.iso.org

Published in Switzerland

Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular, the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see www.iso.org/patents).

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation of the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT), see www.iso.org/iso/foreword.html. (<https://standards.iteh.ai>)

This document was prepared by Technical Committee ISO/TC 163, *Thermal performance and energy use in the built environment*, Subcommittee SC 1, *Test and measurement methods*.

A list of all parts in the ISO 9869 series can be found on the ISO website.

Any feedback or questions on this document should be directed to the user's national standards body. A complete listing of these bodies can be found at www.iso.org/members.html.

Thermal insulation — Building elements — In-situ measurement of thermal resistance and thermal transmittance —

Part 2: Infrared method for frame structure dwelling

AMENDMENT 1: Example of calculation of uncertainty analysis

Annex E

Replace Annex E with the following annex:

iTeh Standards (<https://standards.iteh.ai>) Document Preview

[ISO 9869-2:2018/Amd 1:2021](https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021)

<https://standards.iteh.ai/catalog/standards/iso/01bc53f4-a65c-461a-a696-6446eedf9c39/iso-9869-2-2018-amd-1-2021>

Annex E

(informative)

The calculation example of uncertainty analysis

NOTE This is a simplified uncertainty analysis example for illustrative purpose.

E.1 Listing of uncertainty factors

[Table E.1](#) shows the listing of uncertainty factors.

Table E.1 — Uncertainty factors in measuring the thermal transmittance

Measurement of heat transfer coefficient	Difference in temperature between the heat transfer coefficient sensor and environmental temperature (ET sensor)	Measurement of surface temperature	IR camera specification	Whichever is greater of 2 %, measurement value or $\pm 2^{\circ}\text{C}$
	Measurement of heat flow meter output of the heat transfer coefficient sensor		Thermo-couple specification	$\pm 0,2^{\circ}\text{C}$
Heat flow rate	Difference in temperature between the surface temperature of the heat transfer coefficient sensor and environmental temperature (ET sensor)	Measurement of voltage	Data logger specification	$\pm 6 \mu\text{V}$
	Measurement of heat flow meter output of the heat transfer coefficient sensor		IR camera specification	Whichever is greater of 2 %, measurement value or $\pm 2^{\circ}\text{C}$
	Measurement of surface temperature of the wall	Measurement of voltage	Thermo-couple specification	$\pm 0,2^{\circ}\text{C}$
Thermal transmittance	Difference in temperature between the surface temperature of the heat transfer coefficient sensor and environmental temperature (ET sensor)	Measurement of surface temperature	Data logger specification	$\pm 6 \mu\text{V}$
	Measurement of environmental temperature (measurement of surface temperature of ET sensor)		IR camera specification	Whichever is greater of 2 %, measurement value or $\pm 2^{\circ}\text{C}$
	Measurement of heat flow meter output of the heat transfer coefficient sensor	Measurement of voltage	Thermo-couple specification	$\pm 0,2^{\circ}\text{C}$
			Data logger specification	$\pm 2 \% \text{ of measurement value}$